**Product Description**

DuPont™ Kalrez® 8085 perfluoroelastomer parts are a beige, general purpose product for “select” etch, ash/strip and deposition processes. It has been formulated for minimal particle generation in NF3 plasma. Kalrez® 8085 exhibits very low particle generation and low weight loss in oxygen and fluorine-based plasmas, has excellent mechanical strength and is well-suited for both static and dynamic sealing applications (e.g., bonded slit valve doors, bonded gate valves, bonded pendulum valves, gas orifice seals, gas feedthrough seals, chamber lid seals, etc.) A maximum continuous service temperature of 240 °C is suggested. Kalrez® 8085 can also withstand short-term excursions to 275 °C. Ultrapure post-cleaning and packaging is standard for all Kalrez® 8085 parts.

**Performance Features/Benefits**

- Very low particle generation in NF3 plasma
- Excellent mechanical strength properties
- Longer seal life
- Reduced PM time and increased equipment uptime
- Lower cost of ownership

**Suggested Applications**

- Bonded slit valve door seals
- Bonded gate valves
- Chamber lid seals
- Gas inlet seals
- Gas orifice seals
- Gas feedthrough seals

**Typical Physical Properties**

<table>
<thead>
<tr>
<th>Property</th>
<th>Value</th>
</tr>
</thead>
<tbody>
<tr>
<td>Color</td>
<td>Beige</td>
</tr>
<tr>
<td>Hardness, Shore A (pellet)</td>
<td>80</td>
</tr>
<tr>
<td>Hardness, Shore M (O-ring)</td>
<td>86</td>
</tr>
<tr>
<td>100% Modulus, MPa</td>
<td>7.5</td>
</tr>
<tr>
<td>Tensile Strength at Break, MPa</td>
<td>16.3</td>
</tr>
<tr>
<td>Elongation at Break, %</td>
<td>159</td>
</tr>
<tr>
<td>Compression Set, %</td>
<td>28</td>
</tr>
<tr>
<td>70 hr at 150 °C</td>
<td>35</td>
</tr>
<tr>
<td>70 hr at 175 °C</td>
<td>42</td>
</tr>
<tr>
<td>Max. Continuous Service Temperature, °C</td>
<td>240</td>
</tr>
<tr>
<td>Max. Excursion Temperature, °C</td>
<td>275</td>
</tr>
</tbody>
</table>

1 Not to be used for specification purposes
2 ASTM D2240 (pellet test specimens)
3 ASTM D2240 and ASTM D1414 (AS568 K214 O-ring test specimens)
4 ASTM D412 (dumbbell test specimens)
5 ASTM D3955B and ASTM D1414 (AS568 K214 O-ring test specimens)
6 DuPont proprietary test methods

**Fabs Choose Kalrez® 8085 for Improved Performance**

Kalrez® 8085 has been reported to significantly improve wafer production in a variety of semiconductor plasma process applications where oxygen and fluorinated plasmas are used during the cleaning cycle. In a number of evaluations at fabline customers, Kalrez® 8085 exhibited improved mechanical strength, lower particle generation and longer seal life compared to competitive perfluoroelastomer parts in both static and dynamic sealing applications.
**Case Report #3137 — DuPont™ Kalrez® 8085**
*Reported to Reduce Particle Adders by 53% Over Competitive Perfluoroelastomer (FFKM A11)*
- HDPCVD O-ring
- Process chemistry: Silane
- Cleaning chemistry: NF₃, O₂ and O₃
- Competitive FFKM generated significantly more particle adders

![Graph showing particle reduction](image)

**Case Report #4115 — Kalrez® 8085 Extended Seal Life 100% versus Competitive Perfluoroelastomer (FFKM A18)**
- PECVD RPS cleaning module O-ring seals
- Process chemistry: SiH₄, O₂
- Cleaning chemistry: NF₃
- Competitive perfluoroelastomer failed due to severe plasma attack, i.e., erosion, cracking, etc.

**Case Report #6553 — Kalrez® 8085 Improved Wafer Production over 25% versus Competitive Perfluoroelastomer (FFKM A2)**
- PECVD gas box, shower head and plate seal
- Process chemistry: TEOS, O₂ at 400 °C
- Cleaning chemistry: NF₃ plasma at 3500 watts
- Competitive perfluoroelastomer failed due to cracking and excessive leakage

**Case Report #2883 — Kalrez® 8085 Extended Seal Life 100% versus Competitive Perfluoroelastomer (FFKM A2)**
- Ash isolation valve poppet seal
- Process chemistry: O₂, CF₄
- Cleaning chemistry: N/A
- Competitive perfluoroelastomer failed due to cracking and excessive leakage

Visit us at kalrez.dupont.com or vespel.dupont.com

Contact DuPont at the following regional locations:

<table>
<thead>
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<th>Contact Information</th>
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